

PARA LIGHT ELECTRONICS CO., LTD.

11F, No.8, Jiankang Rd,Zhonghe Dist,New Taipei City 253, TaiwanTel: 886-2-2225-3733Fax: 886-2-2225-4800E-mail: para@para.com.twhttp://www.para.com.tw

DATA SHEET

PART NO.:L-C295JYJGCT-U1

REV: <u>A / 2</u>

CUSTOMER'S APPROVAL: _ DRAWING NO.: DS-78-14-0016 _____ DCC: DATE:2021-12-03 P

Page

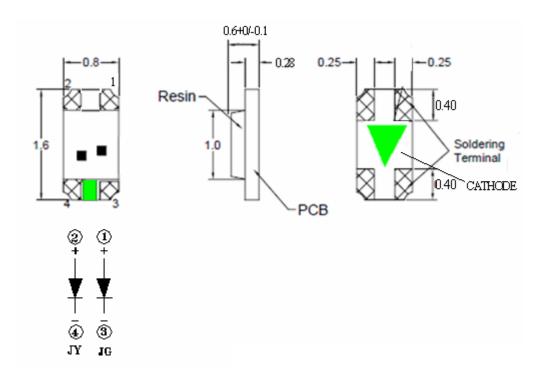
1



Part No.:L-C295JYJGCT-U1

REV:A/2

• PACKAGE OUTLINE DIMENSIONS



Note:

1. All dimensions are in millimeters.

2.Tolerance is±0.1mm (.004") unless otherwise noted

• Features

- * Dual color, top view, wide view angle Chip LED.
- * Package in 8mm tape on 7" diameter reels.
- * Compatible with automatic Pick & Place equipment.
- * Compatible with Reflow soldering and Wave soldering processes.
- * EIA STD package.
- * I.C. compatible.
- * Pb free product.
- * Moisture sensitivity level: 3

DRAWING NO.: DS-78-14-0016

DATE: 2021-12-03 PAGE 2 of 14



Part No.:L-C295JYJGCT-U1

REV:A/2

• Chip Materials

chip	Light Color	Dice Material	Lens Color
JY	Yellow	AlInGap	Watar Clear
JG	Green	AlInGap	Water Clear

• Absolute Maximum Ratings (Ta=25°C)

Symbol	Parameter	Rati	Unit		
Symbol	r ai ametei	Yellow	Green	Oint	
PD	Power Dissipation	75	60	mW	
Inc	Peak Forward Current	80	(0)	mΛ	
Ipf	(1/10 Duty Cycle, 0.1ms Pulse Width)	80	60	mA	
IF	Continuous Forward Current	30	30	mA	
VR	Reverse Voltage	5	5	V	
ESD	Electrostatic Discharge Threshold (HBM)	2000	2000	V	
Topr	Operating Temperature Range	-40 ~ +85		°C	
Tstg	Storage Temperature Range	-40 ~ +85		°C	

• Electro-Optical Characteristics (Ta=25°C)

SYMBOL		PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
VF	Yellow	-Forward Voltage	IF = 20mA	1.8	1.9	2.4	V
	Green		IF = 20IIA	1.8	2.0	2.4	
IV	Yellow	Luminous Intensity	IF = 20mA	45	72	180	mcd
IV	Green		IF = 20IIA	28	45	112	
201/2		Half Intensity Angle	IF = 20mA		130		deg
λD Yellow Green	Yellow	Dominant Wavelength	IF = 20mA	587	590	596	nm
	Dominant wavelength	II = 2011A	567	570	576	nm	
Δλ Yellow Green	Yellow				16		nm
	Green	Spectral Line Half-Width	IF = 20mA		15		nm
IR	Yellow	Reverse Current	VR = 5V			10	۸
	Green		VK = 5V				μA

DRAWING NO.: DS-78-14-0016

DATE: 2021-12-03

PAGE 3 of 14



REV:A/2

Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Caution in ESD:

Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

5. Major standard testing equipment by "Instrument System" Model: CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model: 2400.

• Typical Electro-Optical Characteristics Curves

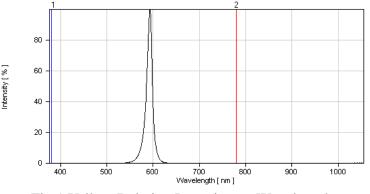


Fig.1 Yellow Relative Intensity vs. Wavelength

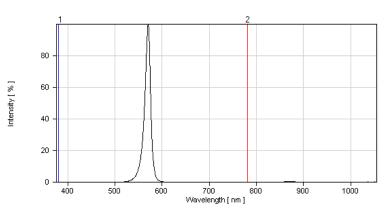


Fig.1 Green Relative Intensity vs. Wavelength

DRAWING NO.: DS-78-14-0016

DATE: 2021-12-03

PAGE 4 of 14

PARA-FOR-068



Part No.:L-C295JYJGCT-U1

REV:A/2

• Yellow Typical Electro-Optical Characteristics Curves

(25°CAmbient Temperature Unless Otherwise Noted)

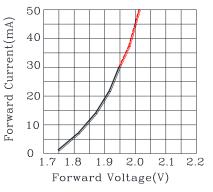


Fig.2 Forward Current vs.Forward Voltage

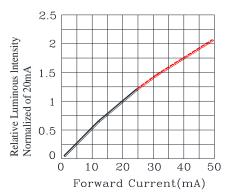
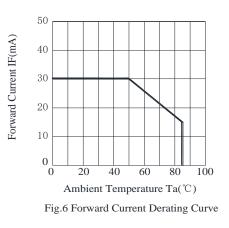
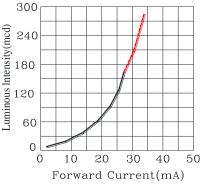


Fig.4 Relative Luminous Intensity vs.Forward Current







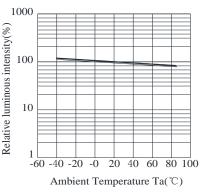
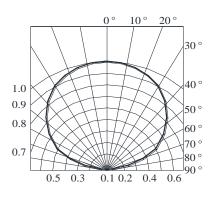


Fig.5 Luminous Intensity vs.Ambient Temperature





DRAWING NO.: DS-78-14-0016

DATE: 2021-12-03 PAGE 5 of 14



Part No.:L-C295JYJGCT-U1

REV:A/2

• Green Typical Electro-Optical Characteristics Curves

(25°CAmbient Temperature Unless Otherwise Noted)

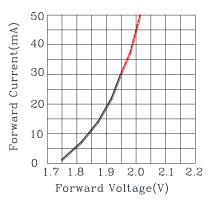


Fig.2 Forward Current vs.Forward Voltage

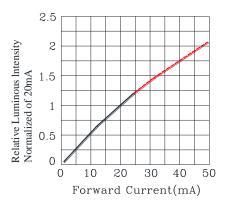


Fig.4 Relative Luminous Intensity vs.Forward Current

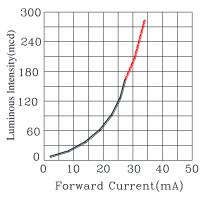


Fig.3 Luminous Intensity vs.Forward Current

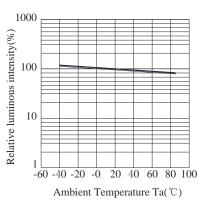
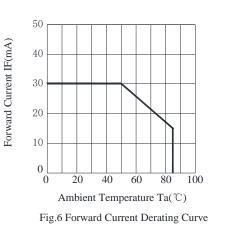


Fig.5 Luminous Intensity vs.Ambient Temperature



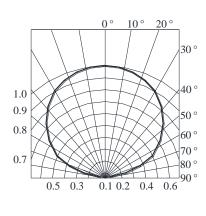


Fig.7 Relative Intensity vs.Angle

DRAWING NO.: DS-78-14-0016

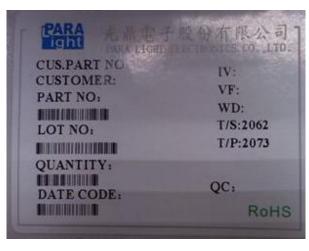
DATE: 2021-12-03 PAGE 6 of 14



Part No.:L-C295JYJGCT

REV:A/2

• Label Explanation



ITEM CODE:PARRA LIGHT

PART NO:L-C295JYJGCT-U1 IV --- Luminous Intensity Code

LOT NO: EM S 0110 L 12 09 В С D E F А A---EM: Emos Code B---S:SMD L---Local D----Year E---Month F---SPEC. PACKING QUANTITY OF BAG: 3000pcs for 150, 170, 110, 155, 115 series 4000pcs for 191 series 5000pcs for 192 series DATE CODE: <u>2012</u> <u>09</u> <u>10</u> G Η Ι

G--- Year H--- Month I --- Day

DRAWING NO.: DS-78-14-0016

DATE: 2021-12-03 PAGE 7 of 14

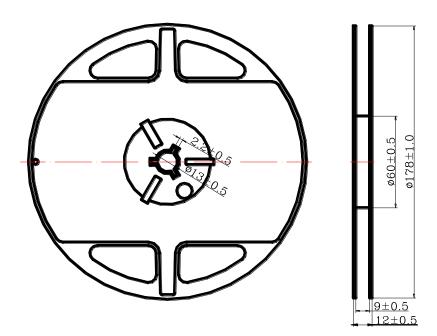
PARA-FOR-068



Part No.:L-C295JYJGCT-U1

REV:A / 2

• Reel Dimensions



Notes:

- 1. Taping Quantity: 4000pcs
- 2. The tolerances unless mentioned is ± 0.1 mm, Angle $\pm 0.5^{\circ}$, Unit: mm.

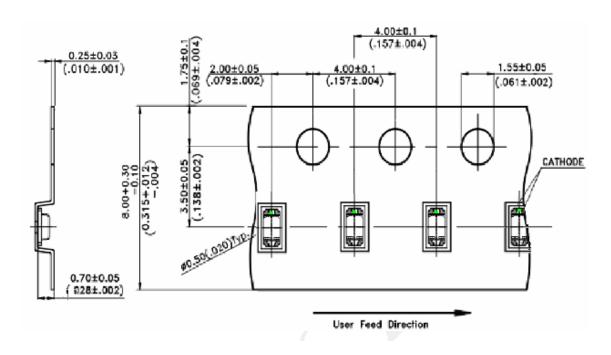
DRAWING NO.: DS-78-14-0016



Part No.:L-C295JYJGCT-U1

REV:A/2

• Package Dimensions Of Tape And Reel



Notes: All dimensions are in millimeters.

DRAWING NO.: DS-78-14-0016

DATE: 2021-12-03 PAGE 9 of 14



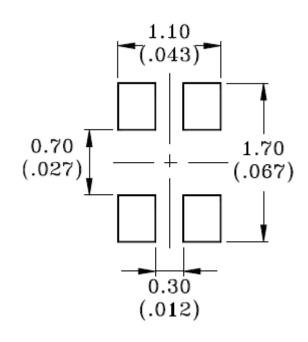
Part No.:L-C295JYJGCT-U1

REV:A/2

• Cleaning

- * If cleaning is required, use the following solutions for less than 1 minute and less than 40° C.
- * Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

Suggest Soldering Pad Dimensions

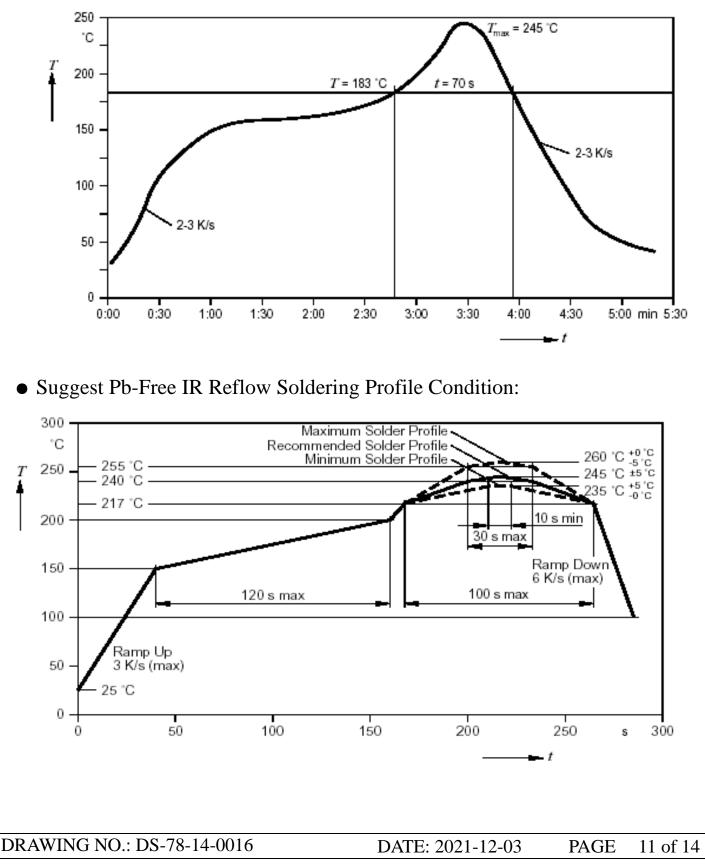




Part No.:L-C295JYJGCT-U1

REV:A/2

• Suggest Sn/Pb IR Reflow Soldering Profile Condition:



PARA-FOR-068



Part No.:L-C295JYJGCT-U1

REV:A/2

• Bin Code List

Luminous Intensity (IV), Unit: mcd@20mA					
Yellow			Green		
Bin Code	Min	Max	Bin Code	Min	Max
Р	45	71	Ν	28	45
Q	71	112	Р	45	71
R	112	180	Q	71	112

Tolerance of each bin are $\pm 15\%$

Dominant Wavelength (Hue), Unit: nm@20mA					
Yellow			Green		
Bin Code	Min	Max	Bin Code	Min	Max
YA	587	590	GA	567	570
YB	590	593	GB	570	573
YC	593	596	GC	573	576

Tolerance of each bin are ± 1 nm

DRAWING NO.: DS-78-14-0016

DATE: 2021-12-03 PAGE 12 of 14



Part No.:L-C295JYJGCT-U1

REV:A / 2

• CAUTIONS

1. Application Limitation:

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2.Storage:

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at 30°C or less and 90% RH or less.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5°C for 24 hours

3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering condition.

Reflow Soldering:

Pre-heat 120~150 °C, 120sec. MAX., Peak temperature : 240 °C Max. Soldering time: 10 sec Max. Soldering Iron: (Not recommended)

Temperature 300 °C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering. Wave soldering:

Pre-heat 100 $^{\circ}$ Max, Pre-heat time 60 sec. Max, Solder wave 260 $^{\circ}$ Max, Soldering time 5 sec. Max. preformed consecutively cooling process is required between 1st and 2nd soldering processes.



Part No.:L-C295JYJGCT-U1

REV:A/2

4. Lead-Free Soldering

For Reflow Soldering:

- 1. Pre-Heat Temp:150-180°C,120sec.Max.
- 2. Soldering Temp: Temperature Of Soldering Pot Over 230°C,40sec.Max.
- 3、Peak Temperature:260°C, 5sec.
- 4. Reflow Repetition:3 Times Max.
- 5. Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi /0.5 Cu

For Soldering Iron (Not Recommended):

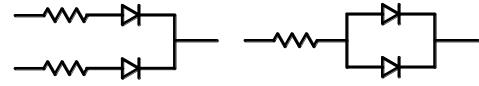
- 1. Iron Tip Temp:350°C Max.
- 2. Soldering Iron:30w Max.
- 3. Soldering Time: 3 Sec. Max. One Time.

For Dip Soldering:

- 1、Pre-Heat Temp:150°C Max. 120 Sec. Max.
- 2、Bath Temp:265°C Max.
- 3、Dip Time:5 Sec. Max.
- 5. Drive Method

Circuit model A

Circuit model B



(A)Recommended circuit.

(B)The difference of brightness between LED's could be found due to the Vf-If characteristics of LED.